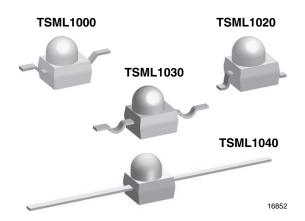
TSML1000, TSML1020, TSML1030, TSML1040

Vishay Semiconductors

High Power Infrared Emitting Diode, 940 nm, GaAlAs, MQW



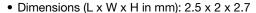
DESCRIPTION

TSML1000 is an infrared, 940 nm emitting diode in GaAlAs multi quantum well (MQW) technology with high radiant power and high speed molded in a clear, untinted plastic package (with lens) for surface mounting (SMD).

FEATURES

Package type: surface mount





Peak wavelength: λ_p = 940 nm

High radiant power

High radiant intensity

• Angle of half intensity: $\varphi = \pm 12^{\circ}$

Low forward voltage

· Suitable for high pulse current operation

· Good spectral matching with Si photodetectors

· Versatile terminal configurations

Package matches with detector TEMT1000

• Floor life: 168 h, MSL 3, acc. J-STD-020

 Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · For remote control
- · Punched tape readers
- Encoder
- Photointerrupters

PRODUCT SUMMARY					
COMPONENT	I _e (mW/sr)	φ (deg)	λ _P (nm)	t _r (ns)	
TSML1000	11	± 12	940	15	
TSML1020	11	± 12	940	15	
TSML1030	11	± 12	940	15	
TSML1040	11	± 12	940	15	

Note

• Test conditions see table "Basic Characteristics"

ORDERING INFORMATION					
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM		
TSML1000	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Reverse gullwing		
TSML1020	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Gullwing		
TSML1030	Tape and reel	MOQ: 1000 pcs, 1000 pcs/reel	Yoke		
TSML1040	Bulk	MOQ: 1000 pcs, 1000 pcs/bulk	Axial leads		

Note

MOQ: minimum order quantity

120

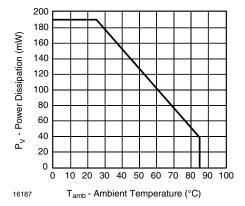
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ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Reverse voltage		V _R	5	V	
Forward current		I _F	100	mA	
Peak forward current	$t_p/T = 0.5, t_p = 100 \mu s$	I _{FM}	200	mA	
Surge forward current	t _p = 100 μs	I _{FSM}	1.0	Α	
Power dissipation		P _V	190	mW	
Junction temperature		T _j	100	°C	
Operating temperature range		T _{amb}	-40 to +85	°C	
Storage temperature range		T _{stg}	-40 to +100	°C	
Soldering temperature	t ≤ 5 s	T _{sd}	< 260	°C	
Thermal resistance junction/ambient	Soldered on PCB, pad dimensions: 4 mm x 4 mm	R _{thJA}	400	°C	



(YE) 80 60 70 80 90 100 16188 T_{amb} - Ambient Temperature (°C)

Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

Fig. 2 - Forward Current vs. Ambient Temperature

BASIC CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	V _F		1.2	1.5	V
	$I_F = 1 \text{ A}, t_p = 100 \mu \text{s}$	V _F		2.2		V
Temperature coefficient of V _F	I _F = 1 mA	TK _{VF}		-1.8		mV/K
Reverse current	V _R = 5 V	I _R			10	μΑ
Junction capacitance	$V_R = 0 \text{ V, } f = 1 \text{ MHz, } E = 0$	Cj		40		pF
Radiant intensity	$I_F = 20 \text{ mA}, t_p = 20 \text{ ms}$	l _e	3	11	15	mW/sr
Radiant power	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	фe		40		mW
Temperature coefficient of φ _e	I _F = 20 mA	TKφ _e		-0.6		%/K
Angle of half intensity		φ		± 12		deg
Peak wavelength	I _F = 100 mA	λρ		940		nm
Spectral bandwidth	I _F = 100 mA	Δλ		30		nm
Temperature coefficient of λ_p	I _F = 100 mA	TKλ _p		0.2		nm/K
Rise time	I _F = 100 mA	t _r		15		ns
Fall time	I _F = 100 mA	t _f		15		ns

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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

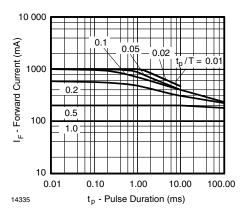


Fig. 3 - Pulse Forward Current vs. Pulse Duration

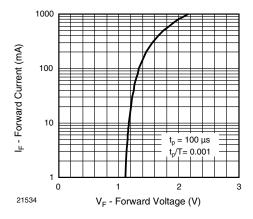


Fig. 4 - Forward Current vs. Forward Voltage

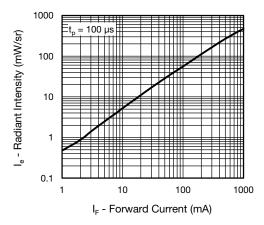


Fig. 5 - Radiant Intensity vs. Forward Current

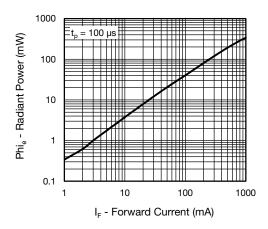


Fig. 6 - Radiant Power vs. Forward Current

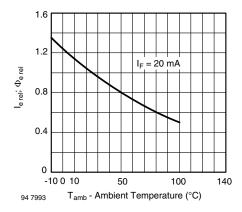


Fig. 7 - Relative Radiant Intensity/Power vs. Ambient Temperature

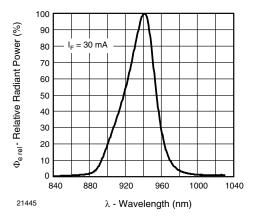


Fig. 8 - Relative Radiant Power vs. Wavelength

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REFLOW SOLDER PROFILE

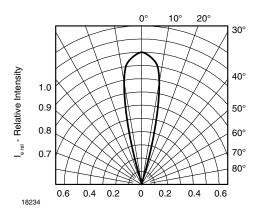


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

PRECAUTIONS FOR USE

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (burn out will happen).

2. Storage

- Storage temperature and rel. humidity conditions are:
 C to 35 °C, R.H. 60 %.
- Floor life must not exceed 168 h, acc. to JEDEC level 3, J-STD-020.
 - Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with desiccant.
 - Considering tape life, we suggest to use products within one year from production date.
- If opened more than one week in an atmosphere 5 °C to 35 °C, R.H. 60 %, devices should be treated at 60 °C ± 5 °C for 15 h.
- If humidity indicator in the package shows pink color (normal blue), then devices should be treated with the same conditions as 2.3.

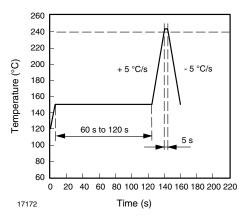


Fig. 10 - Lead Tin (SnPb) Reflow Solder Profile

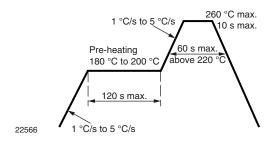
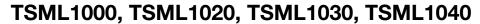


Fig. 11 - Lead (Pb)-Free Reflow Solder Profile acc. J-STD-020

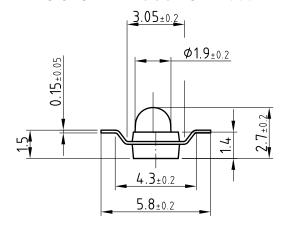




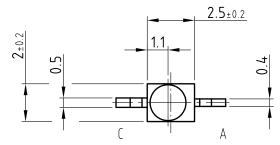
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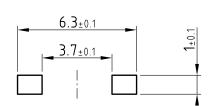
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PACKAGE DIMENSIONS in millimeters: TSML1000









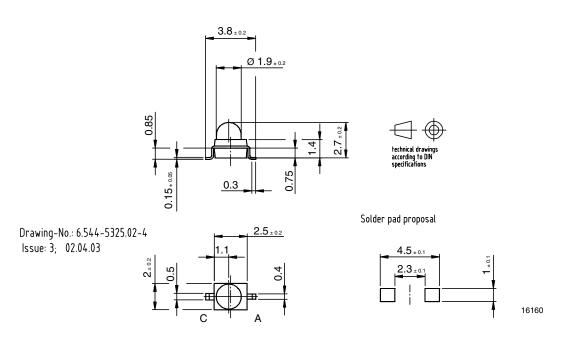
Solder pad proposal

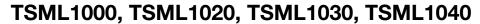
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Issue: 3; 02.04.03

16159

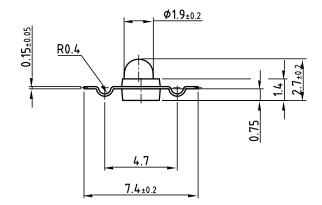
PACKAGE DIMENSIONS in millimeters: TSML1020





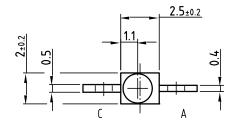
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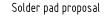
PACKAGE DIMENSIONS in millimeters: TSML1030

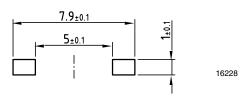


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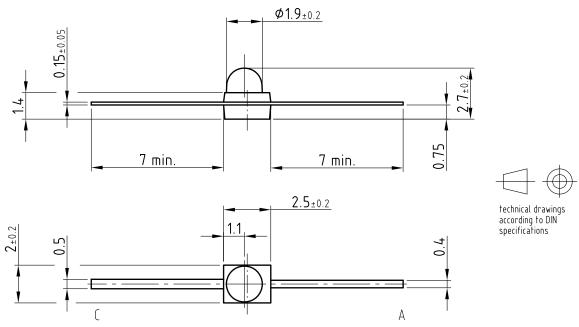








PACKAGE DIMENSIONS in millimeters: TSML1040



Drawing-No.: 6.544-5339.02-4

Issue: 3; 02.04.03

16760

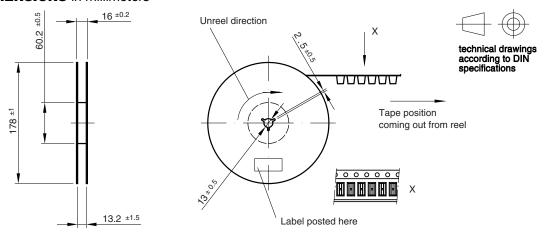




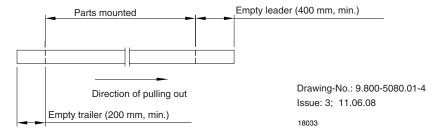
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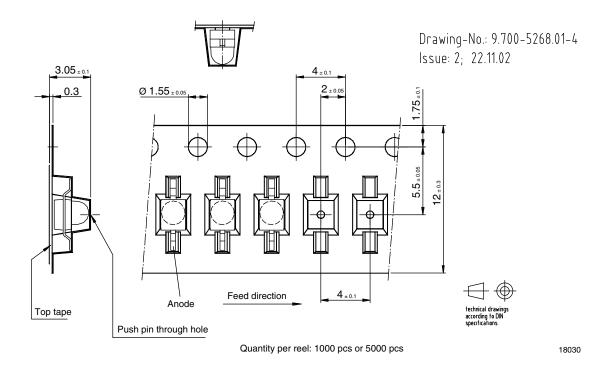
REEL DIMENSIONS in millimeters



Leader and trailer tape:



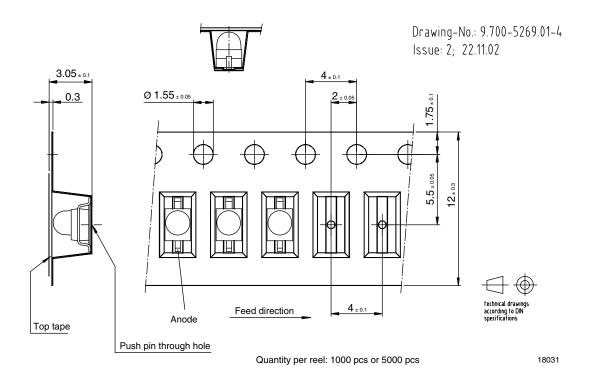
TAPING DIMENSIONS in millimeters: TSML1000



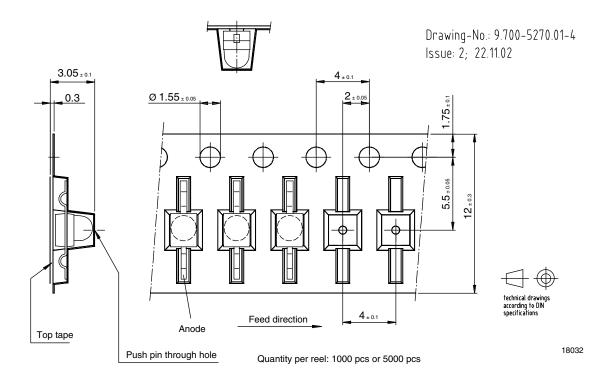
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TAPING DIMENSIONS in millimeters: **TSML1020**



TAPING DIMENSIONS in millimeters: **TSML1030**





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Revision: 02-Oct-12 Document Number: 91000